

PHOTOCOUPLER PS2701A-1

HIGH ISOLATION VOLTAGE SOP PHOTOCOUPLER

-NEPOC Series-

DESCRIPTION

The PS2701A-1 is an optically coupled isolator containing a GaAs light emitting diode and an NPN silicon phototransistor to realize an excellent cost performance.

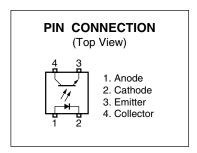
This package is SOP (Small Outline Package) type and has shield effect to cut off ambient light. It is designed for high density mounting applications.

FEATURES

- High isolation voltage (BV = 3 750 Vr.m.s.)
- · SOP (Small Outline Package) type
- · Ordering number of taping product: PS2701A-1-F3, F4
- Pb-Free product
- · Safety standards
 - UL approved: File No. E72422
 - DIN EN60747-5-2 (VDE0884 Part2) approved (Option)

APPLICATIONS

- Hybrid IC
- Measuring instruments
- Power supply
- Programmable logic controllers

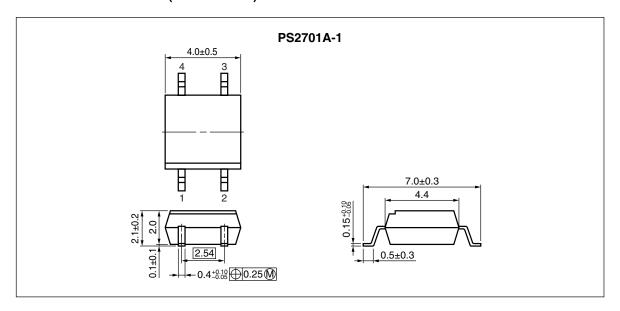


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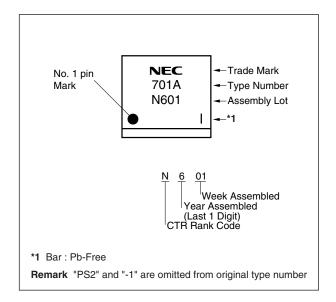
Not all devices/types available in every country. Please check with local NEC Compound Semiconductor Devices representative for availability and additional information.



PACKAGE DIMENSIONS (in millimeters)



MARKING EXAMPLE





★ ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number*1
PS2701A-1	PS2701A-1-A	Pb-Free	Magazine case 100 pcs	Standard products	PS2701A-1
PS2701A-1-F3	PS2701A-1-F3-A		Embossed Tape 3 500 pcs/reel	(UL approved)	
PS2701A-1-F4	PS2701A-1-F4-A				
PS2701A-1-V	PS2701A-1-V-A		Magazine case 100 pcs	DIN EN60747-5-2	
PS2701A-1-V-F3	PS2701A-1-V-F3-A		Embossed Tape 3 500 pcs/reel	(VDE0884 Part2)	
PS2701A-1-V-F4	PS2701A-1-V-F4-A			Approved (Option)	

^{*1} For the application of the Safety Standard, following part number should be used.



ABSOLUTE MAXIMUM RATINGS (TA = 25°C, unless otherwise specified)

Parameter		Symbol	Ratings	Unit	
Diode	le Forward Current (DC) Reverse Voltage		30	mA	
			6	V	
	Power Dissipation Derating	⊿P₀/°C	0.8	mW/°C	
	Power Dissipation	Po	80	mW	
	Peak Forward Current	IFP	0.5	Α	
Transistor	Collector to Emitter Voltage	VCEO	70	V	
	Emitter to Collector Voltage	VECO	5	V	
	Collector Current	lc	30	mA	
	Power Dissipation Derating	⊿Pc/°C	1.5	mW/°C	
	Power Dissipation	Pc	150	mW	
Isolation Voltage ^{*2}		BV	3 750	Vr.m.s.	
Operating Ambient Temperature		TA	-55 to +100	°C	
Storage Temperature		Tstg	-55 to +150	°C	

^{*1} PW = 100 μ s, Duty Cycle = 1%

^{*2} AC voltage for 1 minute at T_A = 25°C, RH = 60% between input and output Pins 1-2 shorted together, 3-4 shorted together.



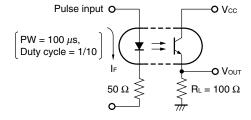
ELECTRICAL CHARACTERISTICS (TA = 25°C)

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	I _F = 5 mA		1.2	1.4	V
	Reverse Current	lr	V _R = 5 V			5	μΑ
	Terminal Capacitance	Ct	V = 0 V, f = 1.0 MHz		10		pF
Transistor	Collector to Emitter Dark Current	Iceo	I _F = 0 mA, V _{CE} = 70 V			100	nA
Coupled	Current Transfer Ratio	CTR	IF = 5 mA, VCE = 5 V	50		300	%
	Collector Saturation Voltage	VCE (sat)	I _F = 10 mA, I _C = 2 mA		0.13	0.3	٧
	Isolation Resistance	R _{I-O}	Vi-o = 1.0 kVDC	10¹¹			Ω
	Isolation Capacitance	C _{I-O}	V = 0 V, f = 1.0 MHz		0.4		pF
	Rise Time *2	t r	$Vcc = 5 \text{ V}, \text{ Ic} = 2 \text{ mA}, \text{ RL} = 100 \Omega$		5		μs
	Fall Time ²	tr			7		

*1 CTR rank

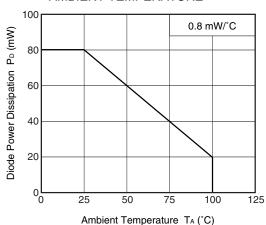
N: 50 to 300 (%)
P: 150 to 300 (%)
L: 100 to 300 (%)
M: 50 to 150 (%)

*2 Test circuit for switching time



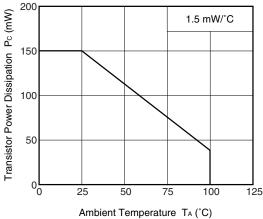
TYPICAL CHARACTERISTICS (TA = 25°C, unless otherwise specified)

DIODE POWER DISSIPATION vs. AMBIENT TEMPERATURE



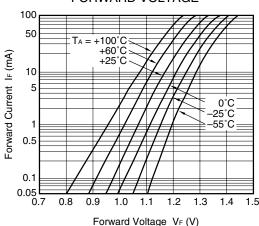
150

AMBIENT TEMPERATURE

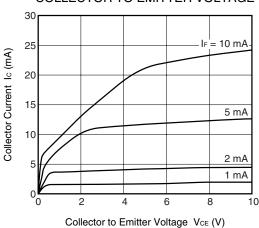


TRANSISTOR POWER DISSIPATION vs.

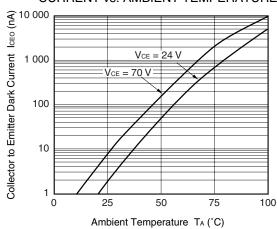
FORWARD CURRENT vs. FORWARD VOLTAGE



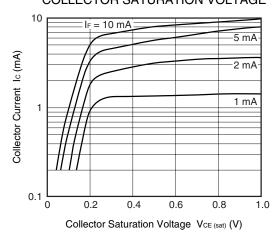
COLLECTOR CURRENT vs. COLLECTOR TO EMITTER VOLTAGE



COLLECTOR TO EMITTER DARK CURRENT vs. AMBIENT TEMPERATURE



COLLECTOR CURRENT vs. COLLECTOR SATURATION VOLTAGE

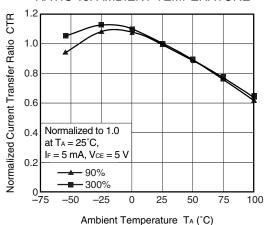


Remark The graphs indicate nominal characteristics.

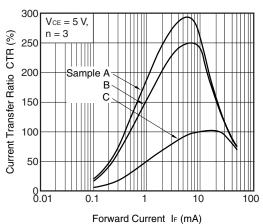
6

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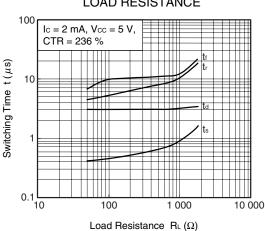
NORMALIZED CURRENT TRANSFER RATIO vs. AMBIENT TEMPERATURE



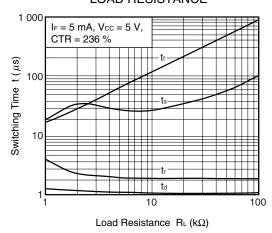
CURRENT TRANSFER RATIO vs. FORWARD CURRENT



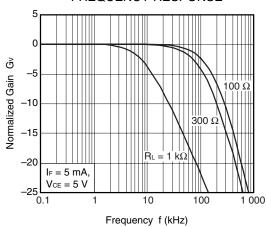
SWITCHING TIME vs. LOAD RESISTANCE



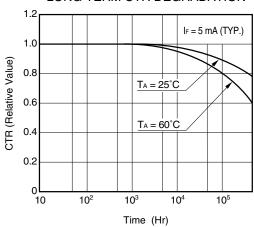
SWITCHING TIME vs. LOAD RESISTANCE



FREQUENCY RESPONSE

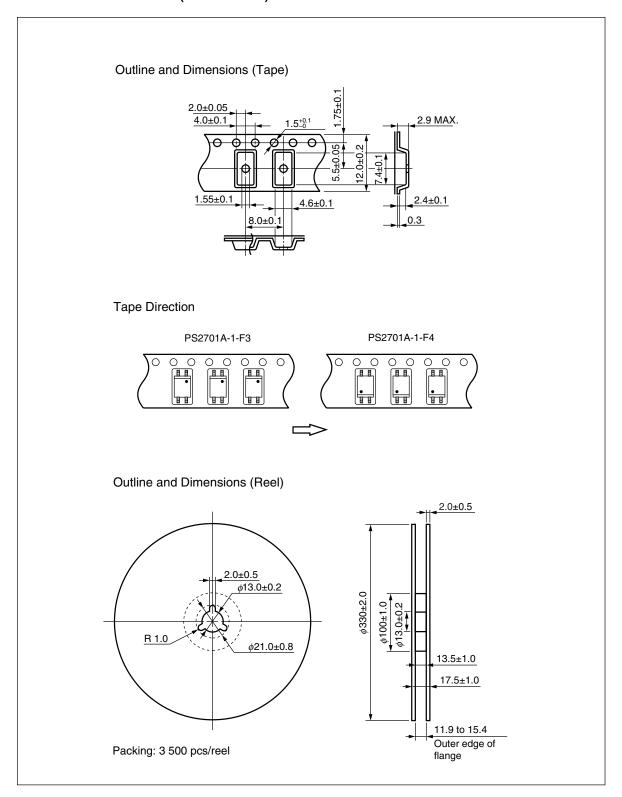


LONG TERM CTR DEGRADATION



Remark The graphs indicate nominal characteristics.

TAPING SPECIFICATIONS (in millimeters)



NOTES ON HANDLING

1. Recommended soldering conditions

(1) Infrared reflow soldering

Peak reflow temperature
 260°C or below (package surface temperature)

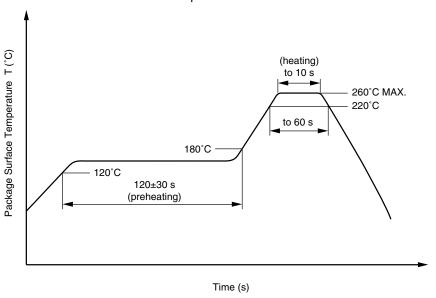
Time of peak reflow temperature
 Time of temperature higher than 220°C
 50 seconds or less
 60 seconds or less

Time to preheat temperature from 120 to 180°C 120±30 s
 Number of reflows Three

Flux
 Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



(2) Wave soldering

• Temperature 260°C or below (molten solder temperature)

• Time 10 seconds or less

Preheating conditions 120°C or below (package surface temperature)

Number of times
 One (Allowed to be dipped in solder including plastic mold portion.)

• Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine

content of 0.2 Wt% is recommended.)

(3) Soldering by soldering iron

Peak temperature (lead part temperature)
 Time (each pins)
 350°C or below
 3 seconds or less

Flux
 Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead.

(b) Please be sure that the temperature of the package would not be heated over 100° C.



(4) Cautions

Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collector-emitters at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

★ 3. Measurement conditions of current transfer ratios (CTR), which differ according to photocoupler

Check the setting values before use, since the forward current conditions at CTR measurement differ according to product.

When using products other than at the specified forward current, the characteristics curves may differ from the standard curves due to CTR value variations or the like. This tendency may sometimes be obvious, especially below $I_F = 1$ mA.

Therefore, check the characteristics under the actual operating conditions and thoroughly take variations or the like into consideration before use.

USAGE CAUTIONS

- 1. Protect against static electricity when handling.
- 2. Avoid storage at a high temperature and high humidity.

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M8E 00.4-0110

NEC PS2701A-1

Caution

GaAs Products

This product uses gallium arsenide (GaAs).

GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.

- Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
- Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
- 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or in any way allow it to enter the mouth.

▶ For further information, please contact

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